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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

David Hoyle, et al.

TI-30564

Art Unit: 2183

Serial No.: 09/703,144

Examiner: Barry J. O'Brien

Filed: October 31, 2000

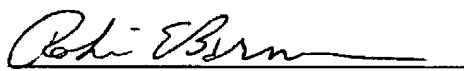
Conf. No.: 1032

For: Microprocessor With Branch-Decrement Instruction

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NAME OF INVENTOR(S): David Hoyle, et al.	
TITLE OF INVENTION: Microprocessor With Branch-Decrement Instruction	
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